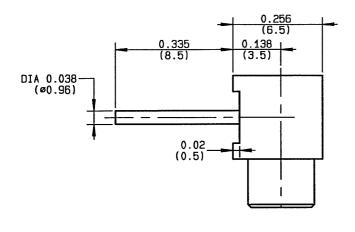
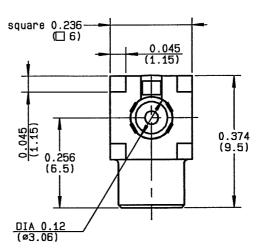
RIGHT ANGLE JACK RECEPTACLE FOR PCB SMT TYPE - PACK. 10

R113.664.030

Series : MCX





All dimensions are in mm.



	COMPONENTS	MATERIALS	PLATINGS (μm)
_	BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS	BRASS BERYLLIUM COPPER - PTFE	GOLD 0.2 OVER NICKEL 2 GOLD 0.5 OVER NICKEL 2

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In the effort to improve our products, we reserve the right to make changes judged to be



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PACKAGING

Standard	Unit	Other
10	•	Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

Impedance 50Ω

VSWR 1.25 + 0.000 x F(GHz) Maxi Insertion loss 0.03 $\sqrt{F(GHz)}$ dB Maxi

RF leakage - (NA - F(GHz)) dB Maxi
Voltage rating 335 Veff Maxi
Dielectric withstanding voltage 1000 Veff mini

Voltage rating -555 Veri Maxi Dielectric withstanding voltage -1000 Verf mini Insulation resistance -1000 MΩ mini

ENVIRONMENTAL

Operating temperature -55/+155 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction

Others:

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

10 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 500 Cycles mini

Weight **1.720** g

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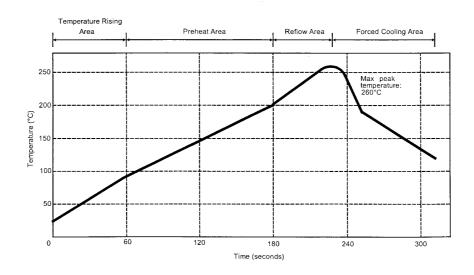
Series: MCX

SOLDER PROCEDURE

- 1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 200 microns (7.800 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. Aspiration port (see page 4) centered into body and push against it.

 Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. Soldering by infra-red reflow. Below, please find the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

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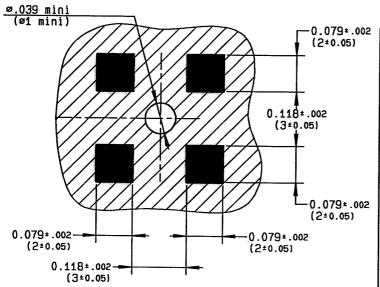


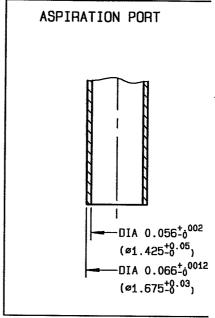
RIGHT ANGLE JACK RECEPTACLE FOR PCB SMT TYPE - PACK. 10

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PCB





COPLANAR LINE
Pattern and signal are on the same side
Thickness of PCB: .063 (1.6 mm)
The material of PCB is the epoxy resin
of glass fabrics bacs.(Er = 4.8)
The solder resist should be printed
exept for the land pattern on the PCB.

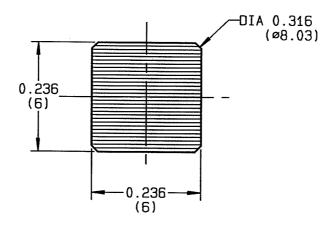


Pattern



Land for solder paste

SHADOW OF MCX RECEPTACLE FOR VIDEO CAMERA



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